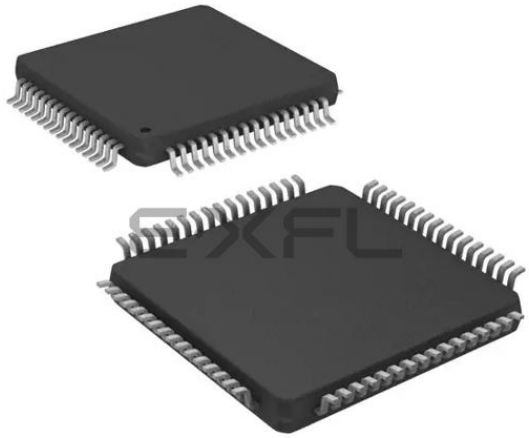

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Applications of "Embedded - Microcontrollers"

Details	
Product Status	Active
Core Processor	PIC
Core Size	8-Bit
Speed	48MHz
Connectivity	I²C, SPI, UART/USART
Peripherals	Brown-out Detect/Reset, LVD, POR, PWM, WDT
Number of I/O	52
Program Memory Size	96KB (48K x 16)
Program Memory Type	FLASH
EEPROM Size	-
RAM Size	3930 x 8
Voltage - Supply (Vcc/Vdd)	2V ~ 3.6V
Data Converters	A/D 11x10b
Oscillator Type	Internal
Operating Temperature	-40°C ~ 85°C (TA)
Mounting Type	Surface Mount
Package / Case	64-TQFP
Supplier Device Package	64-TQFP (10x10)
Purchase URL	https://www.e-xfl.com/product-detail/microchip-technology/pic18f66j16t-i-pt

TABLE 1-4: PIC18F8XJ1X PINOUT I/O DESCRIPTIONS

Pin Name	Pin Number	Pin Type	Buffer Type	Description
	80-TQFP			
$\overline{MCLR}$	9	I	ST	Master Clear (Reset) input. This pin is an active-low Reset to the device.
OSC1/CLKI/RA7	49			Oscillator crystal or external clock input. Available only in External Oscillator modes (EC/ECPLL and HS/HSPLL).
OSC1		I	ST	Main oscillator input connection. Oscillator crystal input or external clock source input. ST buffer when configured in RC mode; CMOS otherwise.
CLKI		I	CMOS	Main clock input connection. External clock source input. Always associated with pin function, OSC1. (See related OSC1/CLKI, OSC2/CLKO pins.)
RA7		I/O	TTL	General purpose I/O pin. Available only in INTIO2 and INTPLL2 Oscillator modes.
OSC2/CLKO/RA6	50			Oscillator crystal or clock output. Available only in External Oscillator modes (EC/ECPLL and HS/HSPLL).
OSC2		O	—	Main oscillator feedback output connection. Oscillator crystal output. Connects to crystal or resonator in Crystal Oscillator mode.
CLKO		O	—	System cycle clock output ($F_{OSC}/4$). In EC, ECPLL, INTIO1 and INTPLL1 Oscillator modes, OSC2 pin outputs CLKO which has 1/4 the frequency of OSC1 and denotes the instruction cycle rate.
RA6		I/O	TTL	General purpose I/O pin. Available only in INTIO and INTPLL Oscillator modes.

Legend: TTL = TTL compatible input; CMOS = CMOS compatible input or output; ST = Schmitt Trigger input with CMOS levels; Analog = Analog input; I = Input; O = Output; P = Power; OD = Open-Drain (no P diode to V_{DD}); I^2C = ST with I^2C™ or SMB levels

Note 1: Alternate assignment for ECCP2/P2A when Configuration bit, CCP2MX, is cleared (Extended Microcontroller mode).
2: Default assignment for ECCP2/P2A for all devices in all operating modes (CCP2MX is set).
3: Default assignments for P1B/P1C/P3B/P3C (ECCPMX Configuration bit is set).
4: Alternate assignment for ECCP2/P2A when CCP2MX is cleared (Microcontroller mode).
5: Alternate assignments for P1B/P1C/P3B/P3C (ECCPMX Configuration bit is cleared).
6: Default assignment for PMP data and control pins when PMPMX Configuration bit is set.
7: Alternate assignment for PMP data and control pins when PMPMX Configuration bit is cleared (programmed).

TABLE 1-4: PIC18F8XJ1X PINOUT I/O DESCRIPTIONS (CONTINUED)

Pin Name	Pin Number	Pin Type	Buffer Type	Description
	80-TQFP			
				PORTD is a bidirectional I/O port.
RD0/AD0/PMD0	72			
RD0		I/O	ST	Digital I/O.
AD0		I/O	TTL	External Memory Address/Data 0.
PMD0(6)		I/O	TTL	Parallel Master Port data.
RD1/AD1/PMD1	69			
RD1		I/O	ST	Digital I/O.
AD1		I/O	TTL	External Memory Address/Data 1.
PMD1(6)		I/O	TTL	Parallel Master Port data.
RD2/AD2/PMD2	68			
RD2		I/O	ST	Digital I/O.
AD2		I/O	TTL	External Memory Address/Data 2.
PMD2(6)		I/O	TTL	Parallel Master Port data.
RD3/AD3/PMD3	67			
RD3		I/O	ST	Digital I/O.
AD3		I/O	TTL	External Memory Address/Data 3.
PMD3(6)		I/O	TTL	Parallel Master Port data.
RD4/AD4/PMD4/SDO2	66			
RD4		I/O	ST	Digital I/O.
AD4		I/O	TTL	External Memory Address/Data 4.
PMD4(6)		I/O	TTL	Parallel Master Port data.
SDO2		O	—	SPI data out.
RD5/AD5/PMD5/ SDI2/SDA2	65			
RD5		I/O	ST	Digital I/O.
AD5		I/O	TTL	External Memory Address/Data 5.
PMD5(6)		I/O	TTL	Parallel Master Port data.
SDI2		I	ST	SPI data in.
SDA2		I/O	ST	I^2C data I/O.
RD6/AD6/PMD6/ SCK2/SCL2	64			
RD6		I/O	ST	Digital I/O.
AD6		I/O	TTL	External Memory Address/Data 6.
PMD6(6)		I/O	TTL	Parallel Master Port data.
SCK2		I/O	ST	Synchronous serial clock input/output for SPI mode.
SCL2		I/O	ST	Synchronous serial clock input/output for I^2C mode.
RD7/AD7/PMD7/$\overline{SS2}$	63			
RD7		I/O	ST	Digital I/O.
AD7		I/O	TTL	External Memory Address/Data 7.
PMD7(6)		I/O	TTL	Parallel Master Port data.
$\overline{SS2}$		I	TTL	SPI slave select input.

Legend: TTL = TTL compatible input; CMOS = CMOS compatible input or output; ST = Schmitt Trigger input with CMOS levels; Analog = Analog input; I = Input; O = Output; P = Power; OD = Open-Drain (no P diode to V_{DD}); I^2C = ST with I^2C™ or SMB levels

Note 1: Alternate assignment for ECCP2/P2A when Configuration bit, CCP2MX, is cleared (Extended Microcontroller mode).
2: Default assignment for ECCP2/P2A for all devices in all operating modes (CCP2MX is set).
3: Default assignments for P1B/P1C/P3B/P3C (ECCPMX Configuration bit is set).
4: Alternate assignment for ECCP2/P2A when CCP2MX is cleared (Microcontroller mode).
5: Alternate assignments for P1B/P1C/P3B/P3C (ECCPMX Configuration bit is cleared).
6: Default assignment for PMP data and control pins when PMPMX Configuration bit is set.
7: Alternate assignment for PMP data and control pins when PMPMX Configuration bit is cleared (programmed).

6.1.6.4 Stack Full and Underflow Resets

Device Resets on stack overflow and stack underflow conditions are enabled by setting the STVREN bit in Configuration Register 1L. When STVREN is set, a full or underflow condition will set the appropriate STKFUL or STKUNF bit and then cause a device Reset. When STVREN is cleared, a full or underflow condition will set the appropriate STKFUL or STKUNF bit, but not cause a device Reset. The STKFUL or STKUNF bits are cleared by the user software or a Power-on Reset.

6.1.7 FAST REGISTER STACK

A Fast Register Stack is provided for the STATUS, WREG and BSR registers to provide a “fast return” option for interrupts. This stack is only one level deep and is neither readable nor writable. It is loaded with the current value of the corresponding register when the processor vectors for an interrupt. All interrupt sources will push values into the Stack registers. The values in the registers are then loaded back into the working registers if the `RETFIE, FAST` instruction is used to return from the interrupt.

If both low and high-priority interrupts are enabled, the Stack registers cannot be used reliably to return from low-priority interrupts. If a high-priority interrupt occurs while servicing a low-priority interrupt, the Stack register values stored by the low-priority interrupt will be overwritten. In these cases, users must save the key registers in software during a low-priority interrupt.

If interrupt priority is not used, all interrupts may use the Fast Register Stack for returns from interrupt. If no interrupts are used, the Fast Register Stack can be used to restore the STATUS, WREG and BSR registers at the end of a subroutine call. To use the Fast Register Stack for a subroutine call, a `CALL label, FAST` instruction must be executed to save the STATUS, WREG and BSR registers to the Fast Register Stack. A `RETURN, FAST` instruction is then executed to restore these registers from the Fast Register Stack.

Example 6-1 shows a source code example that uses the Fast Register Stack during a subroutine call and return.

EXAMPLE 6-1: FAST REGISTER STACK CODE EXAMPLE

```
CALL SUB1, FAST    ;STATUS, WREG, BSR
                   ;SAVED IN FAST REGISTER
                   ;STACK
       •
       •

SUB1   •
       •
   RETURN FAST     ;RESTORE VALUES SAVED
                   ;IN FAST REGISTER STACK
```

6.1.8 LOOK-UP TABLES IN PROGRAM MEMORY

There may be programming situations that require the creation of data structures, or look-up tables, in program memory. For PIC18 devices, look-up tables can be implemented in two ways:

- Computed `GOTO`
- Table Reads

6.1.8.1 Computed GOTO

A computed `GOTO` is accomplished by adding an offset to the Program Counter. An example is shown in Example 6-2.

A look-up table can be formed with an `ADDWF PCL` instruction and a group of `RETLW nn` instructions. The W register is loaded with an offset into the table before executing a call to that table. The first instruction of the called routine is the `ADDWF PCL` instruction. The next instruction executed will be one of the `RETLW nn` instructions that returns the value, ‘nn’, to the calling function.

The offset value (in WREG) specifies the number of bytes that the Program Counter should advance and should be multiples of 2 (LSb = `0`).

In this method, only one data byte may be stored in each instruction location and room on the return address stack is required.

EXAMPLE 6-2: COMPUTED GOTO USING AN OFFSET VALUE

```
        MOVF   OFFSET, W
        CALL   TABLE
ORG     nn00h
TABLE   ADDWF  PCL
        RETLW  nnh
        RETLW  nnh
        RETLW  nnh
        .
        .
        .
```

6.1.8.2 Table Reads

A better method of storing data in program memory allows two bytes of data to be stored in each instruction location.

Look-up table data may be stored, two bytes per program word, while programming. The Table Pointer (TBLPTR) specifies the byte address and the Table Latch (TABLAT) contains the data that is read from the program memory. Data is transferred from program memory, one byte at a time.

Table read operation is discussed further in **Section 7.1 “Table Reads and Table Writes”**.

REGISTER 6-3: WDTCON: WATCHDOG TIMER CONTROL REGISTER

R/W-0	R-x	U-0	R/W-0	U-0	U-0	U-0	U-0
REGSLP	LVDSTAT	—	ADSHR	—	—	—	SWDTEN
bit 7							bit 0

Legend:			
R = Readable bit	W = Writable bit	U = Unimplemented bit, read as ‘0’	
-n = Value at POR	‘1’ = Bit is set	‘0’ = Bit is cleared	x = Bit is unknown

bit 7 **REGSLP:** Voltage Regulator Low-Power Operation Enable bit
For details of bit operation, see Register 25-9.

bit 6 **LVDSTAT:** LVD Status bit
1 = V_{DDCORE} > 2.45V
0 = V_{DDCORE} < 2.45V

bit 5 **Unimplemented**: Read as ‘0’

bit 4 **ADSHR:** Shared Address SFR Select bit
1 = Alternate SFR is selected
0 = Default (Legacy) SFR is selected

bit 3-1 **Unimplemented**: Read as ‘0’

bit 0 **SWDTEN:** Software Controlled Watchdog Timer Enable bit
For details of bit operation, see Register 25-9.

7.5.2 FLASH PROGRAM MEMORY WRITE SEQUENCE (WORD PROGRAMMING).

The PIC18F87J11 family of devices have a feature that allows programming a single word (two bytes). This feature is enable when the WPROG bit is set. If the memory location is already erased, the following sequence is required to enable this feature:

1. Load the Table Pointer register with the address of the data to be written
2. Write the 2 bytes into the holding registers and perform a table write
3. Set the WREN bit (EECON1<2>) to enable byte writes.
4. Disable interrupts.
5. Write H'55' to EECON2.
6. Write H'AA' to EECON2.
7. Set the WR bit. This will begin the write cycle.
8. The CPU will stall for duration of the write for TIW (see Parameter D133A).
9. Re-enable interrupts.

EXAMPLE 7-4: SINGLE-WORD WRITE TO FLASH PROGRAM MEMORY

```
                MOVLW    CODE_ADDR_UPPER      ; Load TBLPTR with the base address
                MOVWF    TBLPTRU
                MOVLW    CODE_ADDR_HIGH
                MOVWF    TBLPTRH
                MOVLW    CODE_ADDR_LOW
                MOVWF    TBLPTRL

                MOVLW    DATA0
                MOVWF    TABLAT
                TBLWT*+
                MOVLW    DATA1
                MOVWF    TABLAT
                TBLWT*


PROGRAM_MEMORY
                BSF     EECON1, WPROG        ; enable single word write
                BSF     EECON1, WREN         ; enable write to memory
                BCF     INTCON, GIE          ; disable interrupts
                MOVLW   H'55'
    Required    MOVWF   EECON2               ; write H'55'
    Sequence    MOVLW   H'AA'
                MOVWF   EECON2               ; write H'AA'
                BSF     EECON1, WR           ; start program (CPU stall)
                BSF     INTCON, GIE          ; re-enable interrupts
                BCF     EECON1, WPROG        ; disable single word write
                BCF     EECON1, WREN         ; disable write to memory
```

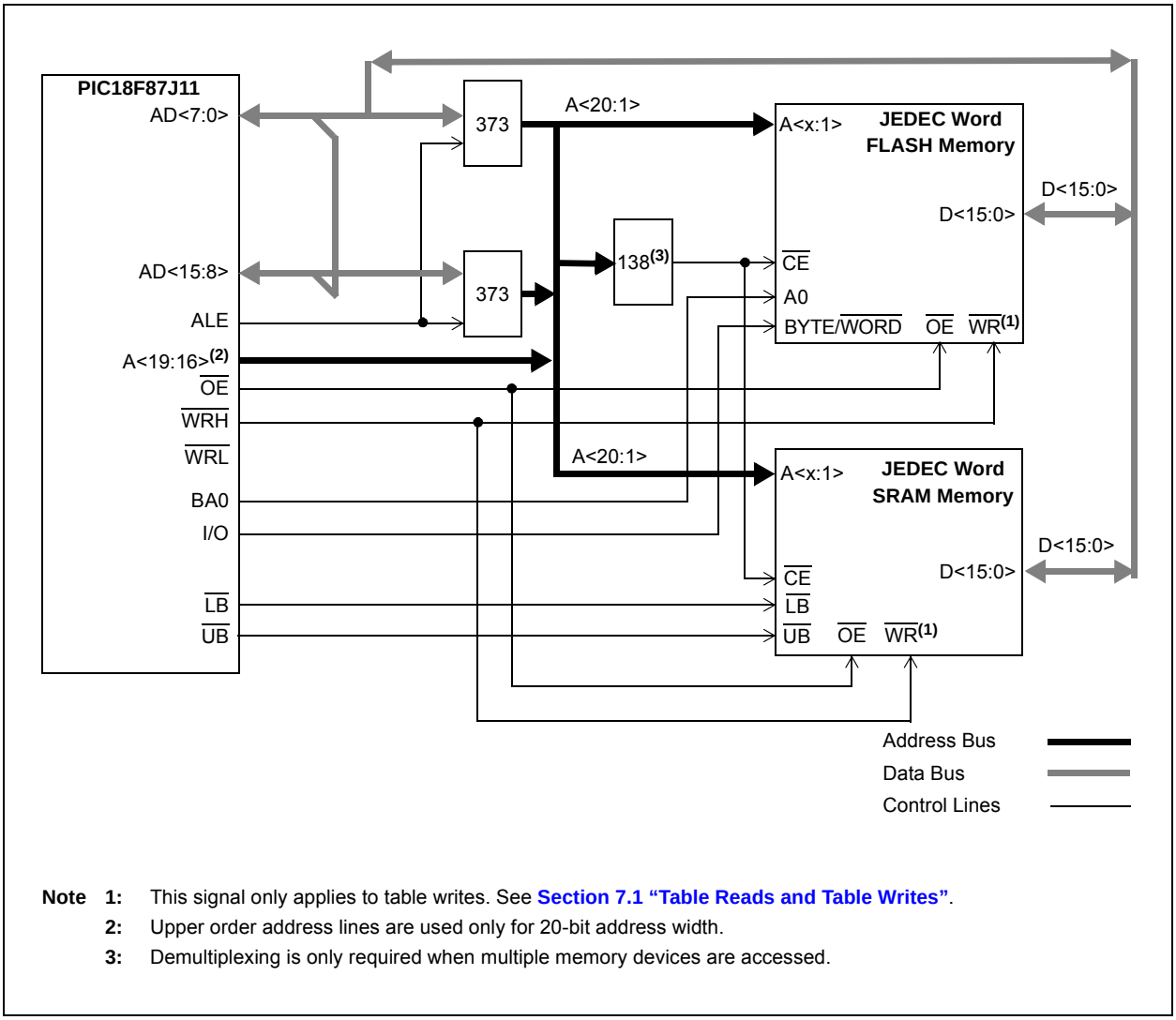
8.6.3 16-BIT BYTE SELECT MODE

Figure 8-3 shows an example of 16-Bit Byte Select mode. This mode allows table write operations to word-wide external memories with byte selection capability. This generally includes both word-wide Flash and SRAM devices.

During a TBLWT cycle, the TABLAT data is presented on the upper and lower byte of the AD<15:0> bus. The $\overline{WRH}$ signal is strobed for each write cycle; the $\overline{WRL}$ pin is not used. The BA0 or $\overline{UB}$/$\overline{LB}$ signals are used to select the byte to be written, based on the Least Significant bit of the TBLPTR register.

Flash and SRAM devices use different control signal combinations to implement Byte Select mode. JEDEC standard Flash memories require that a controller I/O port pin be connected to the memory's BYTE/$\overline{WORD}$ pin to provide the select signal. They also use the BA0 signal from the controller as a byte address. JEDEC standard static RAM memories, on the other hand, use the $\overline{UB}$ or $\overline{LB}$ signals to select the byte.

FIGURE 8-3: 16-BIT BYTE SELECT MODE EXAMPLE



Note 1: This signal only applies to table writes. See **Section 7.1 "Table Reads and Table Writes"**.

2: Upper order address lines are used only for 20-bit address width.

3: Demultiplexing is only required when multiple memory devices are accessed.

10.3 PIE Registers

The PIE registers contain the individual enable bits for the peripheral interrupts. Due to the number of peripheral interrupt sources, there are three Peripheral Interrupt Enable registers (PIE1, PIE2, PIE3). When IPEN = 0, the PEIE bit must be set to enable any of these peripheral interrupts.

REGISTER 10-7: PIE1: PERIPHERAL INTERRUPT ENABLE REGISTER 1

R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0
PMPIE	ADIE	RC1IE	TX1IE	SSP1IE	CCP1IE	TMR2IE	TMR1IE
bit 7							bit 0

Legend:			
R = Readable bit	W = Writable bit	U = Unimplemented bit, read as '0'	
-n = Value at POR	'1' = Bit is set	'0' = Bit is cleared	x = Bit is unknown

bit 7 **PMPIE:** Parallel Master Port Read/Write Interrupt Enable bit
1 = Enables the PM read/write interrupt
0 = Disables the PM read/write interrupt

bit 6 **ADIE:** A/D Converter Interrupt Enable bit
1 = Enables the A/D interrupt
0 = Disables the A/D interrupt

bit 5 **RC1IE:** EUSART1 Receive Interrupt Enable bit
1 = Enables the EUSART1 receive interrupt
0 = Disables the EUSART1 receive interrupt

bit 4 **TX1IE:** EUSART1 Transmit Interrupt Enable bit
1 = Enables the EUSART1 transmit interrupt
0 = Disables the EUSART1 transmit interrupt

bit 3 **SSP1IE:** MSSP1 Interrupt Enable bit
1 = Enables the MSSP1 interrupt
0 = Disables the MSSP1 interrupt

bit 2 **CCP1IE:** ECCP1 Interrupt Enable bit
1 = Enables the ECCP1 interrupt
0 = Disables the ECCP1 interrupt

bit 1 **TMR2IE:** TMR2 to PR2 Match Interrupt Enable bit
1 = Enables the TMR2 to PR2 match interrupt
0 = Disables the TMR2 to PR2 match interrupt

bit 0 **TMR1IE:** TMR1 Overflow Interrupt Enable bit
1 = Enables the TMR1 overflow interrupt
0 = Disables the TMR1 overflow interrupt

TABLE 11-8: PORTC FUNCTIONS

Pin Name	Function	TRIS Setting	I/O	I/O Type	Description
RC0/T1OSO/ T13CKI	RC0	0	O	DIG	LATC<0> data output.
		1	I	ST	PORTC<0> data input.
	T1OSO	x	O	ANA	Timer1 oscillator output; enabled when Timer1 oscillator is enabled. Disables digital I/O.
	T13CKI	1	I	ST	Timer1/Timer3 counter input.
RC1/T1OSI/ ECCP2/P2A	RC1	0	O	DIG	LATC<1> data output.
		1	I	ST	PORTC<1> data input.
	T1OSI	x	I	ANA	Timer1 oscillator input; enabled when Timer1 oscillator is enabled. Disables digital I/O.
	ECCP2(1)	0	O	DIG	ECCP2 compare output and ECCP2 PWM output; takes priority over port data.
		1	I	ST	ECCP2 capture input.
	P2A(1)	0	O	DIG	ECCP2 Enhanced PWM output, Channel A. May be configured for tri-state during Enhanced PWM shutdown events. Takes priority over port data.
RC2/ECCP1/ P1A	RC2	0	O	DIG	LATC<2> data output.
		1	I	ST	PORTC<2> data input.
	ECCP1	0	O	DIG	ECCP1 compare output and ECCP1 PWM output; takes priority over port data.
		1	I	ST	ECCP1 capture input.
	P1A	0	O	DIG	ECCP1 Enhanced PWM output, Channel A. May be configured for tri-state during Enhanced PWM shutdown events. Takes priority over port data.
RC3/SCK1/ SCL1	RC3	0	O	DIG	LATC<3> data output.
		1	I	ST	PORTC<3> data input.
	SCK1	0	O	DIG	SPI clock output (MSSP1 module); takes priority over port data.
		1	I	ST	SPI clock input (MSSP1 module).
	SCL1	0	O	DIG	I^2C™ clock output (MSSP1 module); takes priority over port data.
		1	I	ST	I^2C clock input (MSSP1 module); input type depends on module setting.
RC4/SDI1/ SDA1	RC4	0	O	DIG	LATC<4> data output.
		1	I	ST	PORTC<4> data input.
	SDI1	1	I	ST	SPI data input (MSSP1 module).
	SDA1	1	O	DIG	I^2C data output (MSSP1 module); takes priority over port data.
		1	I	ST	I^2C data input (MSSP1 module); input type depends on module setting.
RC5/SDO1	RC5	0	O	DIG	LATC<5> data output.
		1	I	ST	PORTC<5> data input.
	SDO1	0	O	DIG	SPI data output (MSSP1 module); takes priority over port data.
RC6/TX1/CK1	RC6	0	O	DIG	LATC<6> data output.
		1	I	ST	PORTC<6> data input.
	TX1	1	O	DIG	Synchronous serial data output (EUSART1 module); takes priority over port data.
	CK1	1	O	DIG	Synchronous serial data input (EUSART1 module). User must configure as an input.
		1	I	ST	Synchronous serial clock input (EUSART1 module).
RC7/RX1/DT1	RC7	0	O	DIG	LATC<7> data output.
		1	I	ST	PORTC<7> data input.
	RX1	1	I	ST	Asynchronous serial receive data input (EUSART1 module).
	DT1	1	O	DIG	Synchronous serial data output (EUSART1 module); takes priority over port data.
		1	I	ST	Synchronous serial data input (EUSART1 module). User must configure as an input.

Legend: O = Output, I = Input, ANA = Analog Signal, DIG = Digital Output, ST = Schmitt Buffer Input, TTL = TTL Buffer Input, x = Don't care (TRIS bit does not affect port direction or is overridden for this option).

Note 1: Default assignment for ECCP2/P2A when the CCP2MX Configuration bit is set.

TABLE 11-16: PORTG FUNCTIONS

Pin Name	Function	TRIS Setting	I/O	I/O Type	Description
RG0/PMA8/ ECCP3/P3A	RG0	0	O	DIG	LATG<0> data output.
		1	I	ST	PORTG<0> data input.
	PMA8	x	O	DIG	Parallel Master Port address.
	ECCP3		O	DIG	ECCP3 compare and PWM output; takes priority over port data.
			I	ST	ECCP3 capture input.
	P3A	0	O	DIG	ECCP3 Enhanced PWM output, Channel A; takes priority over port and PMP data. May be configured for tri-state during Enhanced PWM shutdown events.
RG1/PMA7/ TX2/CK2	RG1	0	O	DIG	LATG<1> data output.
		1	I	ST	PORTG<1> data input.
	PMA7	x	O	DIG	Parallel Master Port address.
	TX2	1	O	DIG	Synchronous serial data output (EUSART2 module); takes priority over port data.
	CK2	1	O	DIG	Synchronous serial data input (EUSART2 module). User must configure as an input.
		1	I	ST	Synchronous serial clock input (EUSART2 module).
RG2/PMA6/ RX2/DT2	RG2	0	O	DIG	LATG<2> data output.
		1	I	ST	PORTG<2> data input.
	PMA6	x	O	DIG	Parallel Master Port address.
	RX2	1	I	ST	Asynchronous serial receive data input (EUSART2 module).
	DT2	1	O	DIG	Synchronous serial data output (EUSART2 module); takes priority over port data.
		1	I	ST	Synchronous serial data input (EUSART2 module). User must configure as an input.
RG3/PMCS1/ CCP4/P3D	RG3	0	O	DIG	LATG<3> data output.
		1	I	ST	PORTG<3> data input.
	PMCS1	x	O	DIG	Parallel Master Port Address Chip Select 1
		x	I	TTL	Parallel Master Port Address Chip Select 1.
	CCP4	0	O	DIG	CCP4 compare output and CCP4 PWM output; takes priority over port data.
		1	I	ST	CCP4 capture input.
	P3D	0	O	DIG	ECCP3 Enhanced PWM output, Channel D; takes priority over port and PMP data. May be configured for tri-state during Enhanced PWM shutdown events.
RG4/PMCS2/ CCP5/P1D	RG4	0	O	DIG	LATG<4> data output.
		1	I	ST	PORTG<4> data input.
	PMCS2	x	O	DIG	Parallel Master Port Address Chip Select 2
	CCP5	0	O	DIG	CCP5 compare output and CCP5 PWM output; takes priority over port data.
		1	I	ST	CCP5 capture input.
	P1D	0	O	DIG	ECCP1 Enhanced PWM output, Channel D; takes priority over port and PMP data. May be configured for tri-state during Enhanced PWM shutdown events.

Legend: O = Output, I = Input, DIG = Digital Output, ST = Schmitt Buffer Input, TTL = TTL Buffer Input,
x = Don't care (TRIS bit does not affect port direction or is overridden for this option).

12.3.11 MASTER MODE TIMING

This section contains a number of timing examples that represent the common Master mode configuration options. These options vary from 8-bit to 16-bit data, fully demultiplexed to fully multiplexed address, as well as Wait states.

FIGURE 12-12: READ AND WRITE TIMING, 8-BIT DATA, DEMULTIPLEXED ADDRESS

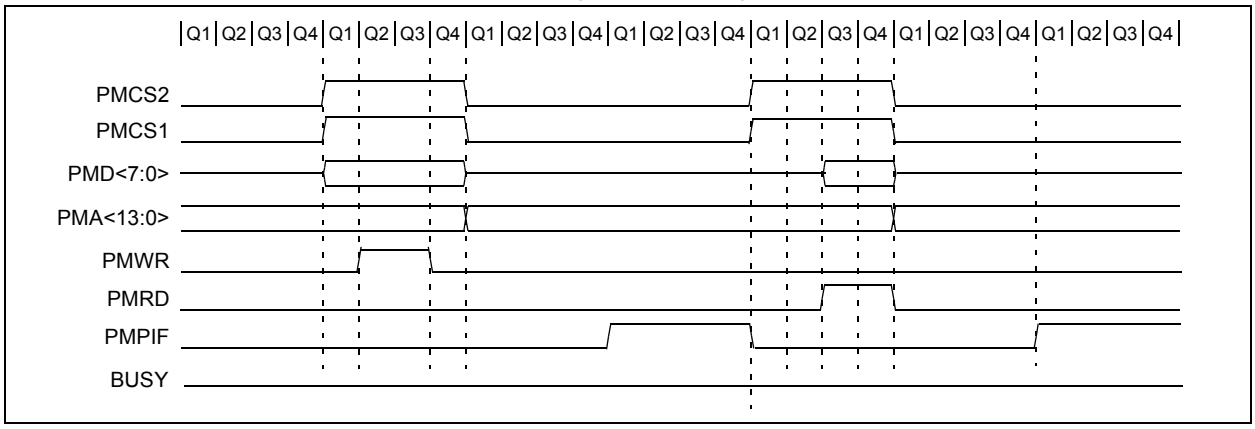


FIGURE 12-13: READ TIMING, 8-BIT DATA, PARTIALLY MULTIPLEXED ADDRESS

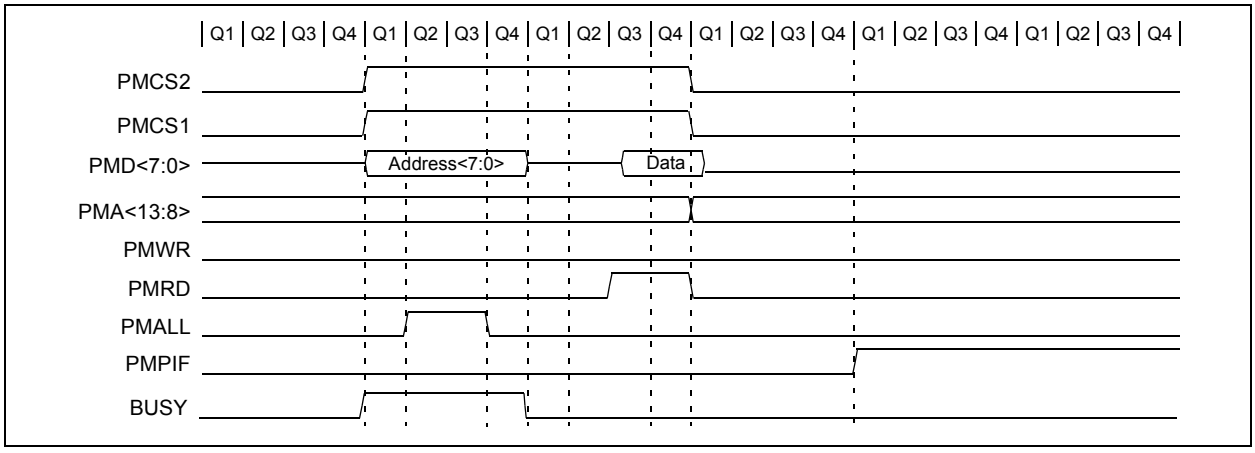


FIGURE 12-20: WRITE TIMING, 8-BIT DATA, FULLY MULTIPLEXED 16-BIT ADDRESS

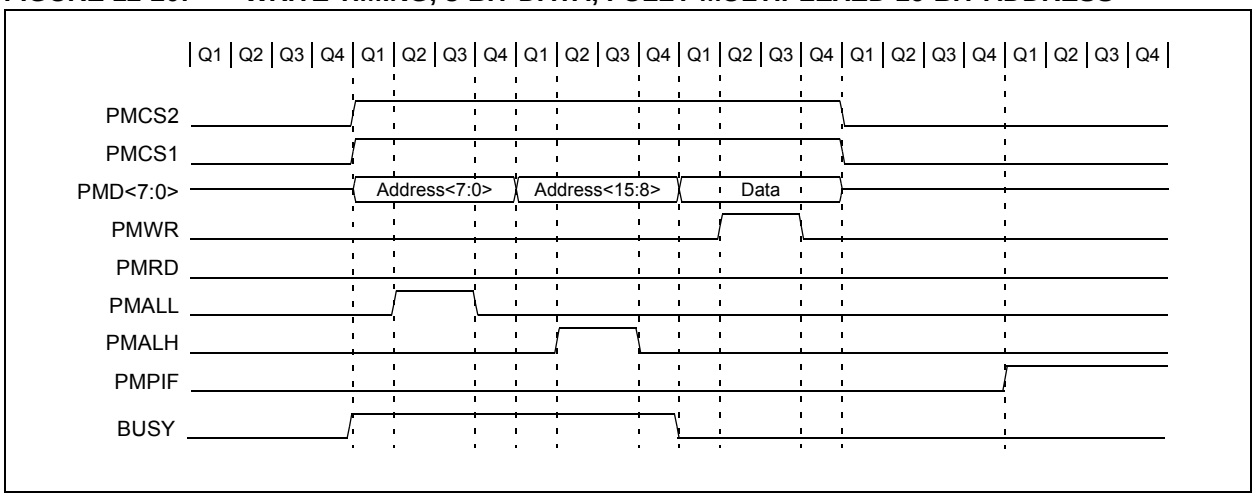


FIGURE 12-21: READ TIMING, 16-BIT DATA, DEMULTIPLEXED ADDRESS

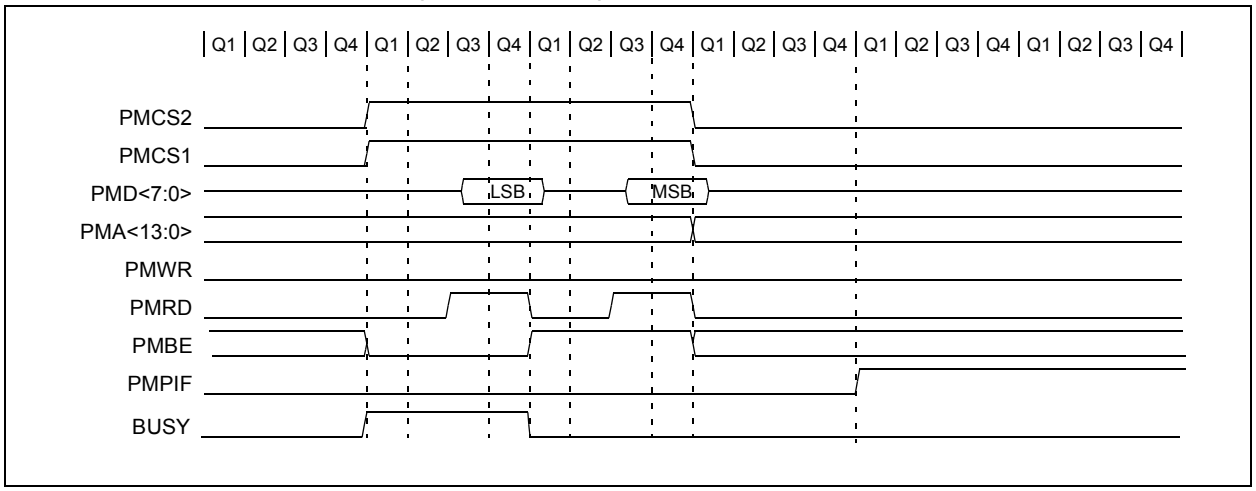
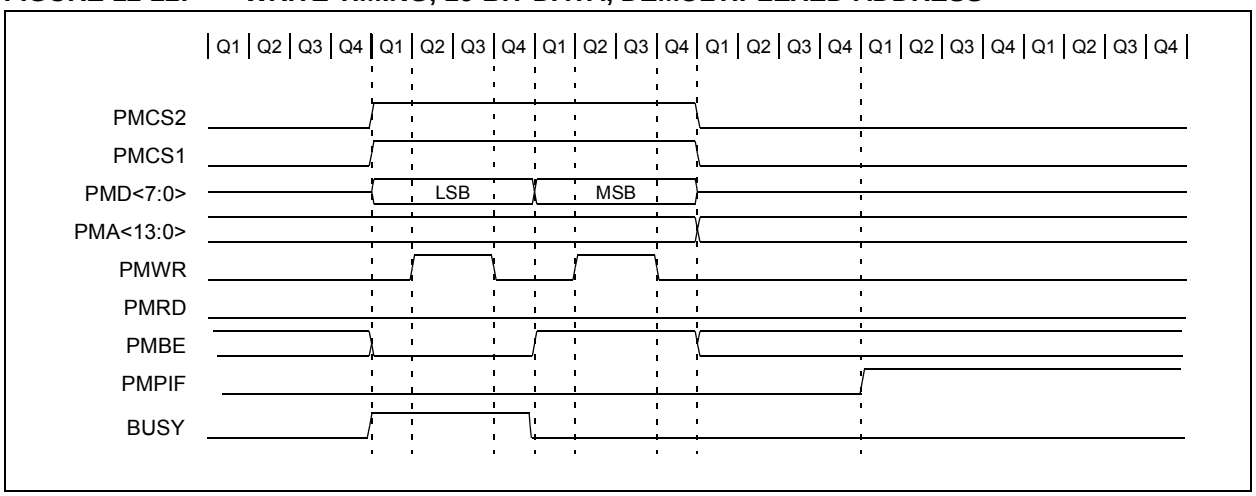


FIGURE 12-22: WRITE TIMING, 16-BIT DATA, DEMULTIPLEXED ADDRESS



17.2 Timer4 Interrupt

The Timer4 module has an 8-bit period register, PR4, which is both readable and writable. Timer4 increments from 00h until it matches PR4 and then resets to 00h on the next increment cycle. The PR4 register is initialized to FFh upon Reset.

17.3 Output of TMR4

The output of TMR4 (before the postscaler) is used only as a PWM time base for the ECCPx/CCPx modules. It is not used as a baud rate clock for the MSSP modules as is the Timer2 output.

FIGURE 17-1: TIMER4 BLOCK DIAGRAM

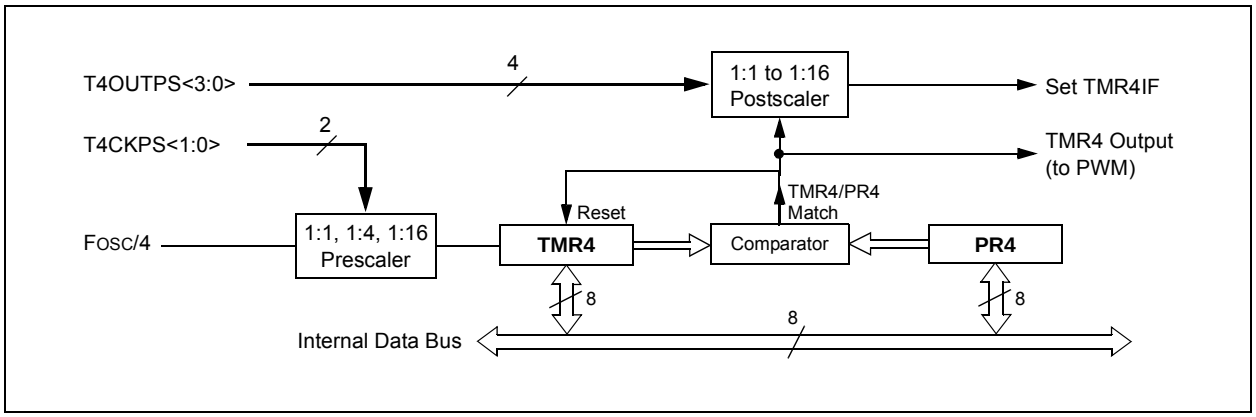


TABLE 17-1: REGISTERS ASSOCIATED WITH TIMER4 AS A TIMER/COUNTER

Name	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0	Reset Values on Page:
INTCON	GIE/GIEH	PEIE/GIEL	TMR0IE	INT0IE	RBIE	TMR0IF	INT0IF	RBIF	61
IPR3	SSP2IP	BCL2IP	RC2IP	TX2IP	TMR4IP	CCP5IP	CCP4IP	CCP3IP	64
PIR3	SSP2IF	BCL2IF	RC2IF	TX2IF	TMR4IF	CCP5IF	CCP4IF	CCP3IF	64
PIE3	SSP2IE	BCL2IE	RC2IE	TX2IE	TMR4IE	CCP5IE	CCP4IE	CCP3IE	64
TMR4	Timer4 Register								65
T4CON	—	T4OUTPS3	T4OUTPS2	T4OUTPS1	T4OUTPS0	TMR4ON	T4CKPS1	T4CKPS0	65
PR4	Timer4 Period Register								65

Legend: — = unimplemented, read as '0'. Shaded cells are not used by the Timer4 module.

TABLE 21-3: BAUD RATES FOR ASYNCHRONOUS MODES

Baud Rate (K)	SYNC = 0, BRGH = 0, BRG16 = 0											
	Fosc = 40.000 MHz			Fosc = 20.000 MHz			Fosc = 10.000 MHz			Fosc = 8.000 MHz		
	Actual Rate (K)	% Error	SPBRG Value (decimal)	Actual Rate (K)	% Error	SPBRG Value (decimal)	Actual Rate (K)	% Error	SPBRG Value (decimal)	Actual Rate (K)	% Error	SPBRG Value (decimal)
0.3	—	—	—	—	—	—	—	—	—	—	—	—
1.2	—	—	—	1.221	1.73	255	1.202	0.16	129	1.201	-0.16	103
2.4	2.441	1.73	255	2.404	0.16	129	2.404	0.16	64	2.403	-0.16	51
9.6	9.615	0.16	64	9.766	1.73	31	9.766	1.73	15	9.615	-0.16	12
19.2	19.531	1.73	31	19.531	1.73	15	19.531	1.73	7	—	—	—
57.6	56.818	-1.36	10	62.500	8.51	4	52.083	-9.58	2	—	—	—
115.2	125.000	8.51	4	104.167	-9.58	2	78.125	-32.18	1	—	—	—

Baud Rate (K)	SYNC = 0, BRGH = 0, BRG16 = 0								
	Fosc = 4.000 MHz			Fosc = 2.000 MHz			Fosc = 1.000 MHz		
	Actual Rate (K)	% Error	SPBRG Value (decimal)	Actual Rate (K)	% Error	SPBRG Value (decimal)	Actual Rate (K)	% Error	SPBRG Value (decimal)
0.3	0.300	0.16	207	0.300	-0.16	103	0.300	-0.16	51
1.2	1.202	0.16	51	1.201	-0.16	25	1.201	-0.16	12
2.4	2.404	0.16	25	2.403	-0.16	12	—	—	—
9.6	8.929	-6.99	6	—	—	—	—	—	—
19.2	20.833	8.51	2	—	—	—	—	—	—
57.6	62.500	8.51	0	—	—	—	—	—	—
115.2	62.500	-45.75	0	—	—	—	—	—	—

Baud Rate (K)	SYNC = 0, BRGH = 1, BRG16 = 0											
	Fosc = 40.000 MHz			Fosc = 20.000 MHz			Fosc = 10.000 MHz			Fosc = 8.000 MHz		
	Actual Rate (K)	% Error	SPBRG Value (decimal)	Actual Rate (K)	% Error	SPBRG Value (decimal)	Actual Rate (K)	% Error	SPBRG Value (decimal)	Actual Rate (K)	% Error	SPBRG Value (decimal)
0.3	—	—	—	—	—	—	—	—	—	—	—	—
1.2	—	—	—	—	—	—	—	—	—	—	—	—
2.4	—	—	—	—	—	—	2.441	1.73	255	2.403	-0.16	207
9.6	9.766	1.73	255	9.615	0.16	129	9.615	0.16	64	9.615	-0.16	51
19.2	19.231	0.16	129	19.231	0.16	64	19.531	1.73	31	19.230	-0.16	25
57.6	58.140	0.94	42	56.818	-1.36	21	56.818	-1.36	10	55.555	3.55	8
115.2	113.636	-1.36	21	113.636	-1.36	10	125.000	8.51	4	—	—	—

Baud Rate (K)	SYNC = 0, BRGH = 1, BRG16 = 0								
	Fosc = 4.000 MHz			Fosc = 2.000 MHz			Fosc = 1.000 MHz		
	Actual Rate (K)	% Error	SPBRG Value (decimal)	Actual Rate (K)	% Error	SPBRG Value (decimal)	Actual Rate (K)	% Error	SPBRG Value (decimal)
0.3	—	—	—	—	—	—	0.300	-0.16	207
1.2	1.202	0.16	207	1.201	-0.16	103	1.201	-0.16	51
2.4	2.404	0.16	103	2.403	-0.16	51	2.403	-0.16	25
9.6	9.615	0.16	25	9.615	-0.16	12	—	—	—
19.2	19.231	0.16	12	—	—	—	—	—	—
57.6	62.500	8.51	3	—	—	—	—	—	—
115.2	125.000	8.51	1	—	—	—	—	—	—

TABLE 21-3: BAUD RATES FOR ASYNCHRONOUS MODES (CONTINUED)

Baud Rate (K)	SYNC = 0, BRGH = 0, BRG16 = 1											
	Fosc = 40.000 MHz			Fosc = 20.000 MHz			Fosc = 10.000 MHz			Fosc = 8.000 MHz		
	Actual Rate (K)	% Error	SPBRG Value (decimal)	Actual Rate (K)	% Error	SPBRG Value (decimal)	Actual Rate (K)	% Error	SPBRG Value (decimal)	Actual Rate (K)	% Error	SPBRG Value (decimal)
0.3	0.300	0.00	8332	0.300	0.02	4165	0.300	0.02	2082	0.300	-0.04	1665
1.2	1.200	0.02	2082	1.200	-0.03	1041	1.200	-0.03	520	1.201	-0.16	415
2.4	2.402	0.06	1040	2.399	-0.03	520	2.404	0.16	259	2.403	-0.16	207
9.6	9.615	0.16	259	9.615	0.16	129	9.615	0.16	64	9.615	-0.16	51
19.2	19.231	0.16	129	19.231	0.16	64	19.531	1.73	31	19.230	-0.16	25
57.6	58.140	0.94	42	56.818	-1.36	21	56.818	-1.36	10	55.555	3.55	8
115.2	113.636	-1.36	21	113.636	-1.36	10	125.000	8.51	4	—	—	—

Baud Rate (K)	SYNC = 0, BRGH = 0, BRG16 = 1								
	Fosc = 4.000 MHz			Fosc = 2.000 MHz			Fosc = 1.000 MHz		
	Actual Rate (K)	% Error	SPBRG Value (decimal)	Actual Rate (K)	% Error	SPBRG Value (decimal)	Actual Rate (K)	% Error	SPBRG Value (decimal)
0.3	0.300	0.04	832	0.300	-0.16	415	0.300	-0.16	207
1.2	1.202	0.16	207	1.201	-0.16	103	1.201	-0.16	51
2.4	2.404	0.16	103	2.403	-0.16	51	2.403	-0.16	25
9.6	9.615	0.16	25	9.615	-0.16	12	—	—	—
19.2	19.231	0.16	12	—	—	—	—	—	—
57.6	62.500	8.51	3	—	—	—	—	—	—
115.2	125.000	8.51	1	—	—	—	—	—	—

Baud Rate (K)	SYNC = 0, BRGH = 1, BRG16 = 1 or SYNC = 1, BRG16 = 1											
	Fosc = 40.000 MHz			Fosc = 20.000 MHz			Fosc = 10.000 MHz			Fosc = 8.000 MHz		
	Actual Rate (K)	% Error	SPBRG Value (decimal)	Actual Rate (K)	% Error	SPBRG Value (decimal)	Actual Rate (K)	% Error	SPBRG Value (decimal)	Actual Rate (K)	% Error	SPBRG Value (decimal)
0.3	0.300	0.00	33332	0.300	0.00	16665	0.300	0.00	8332	0.300	-0.01	6665
1.2	1.200	0.00	8332	1.200	0.02	4165	1.200	0.02	2082	1.200	-0.04	1665
2.4	2.400	0.02	4165	2.400	0.02	2082	2.402	0.06	1040	2.400	-0.04	832
9.6	9.606	0.06	1040	9.596	-0.03	520	9.615	0.16	259	9.615	-0.16	207
19.2	19.193	-0.03	520	19.231	0.16	259	19.231	0.16	129	19.230	-0.16	103
57.6	57.803	0.35	172	57.471	-0.22	86	58.140	0.94	42	57.142	0.79	34
115.2	114.943	-0.22	86	116.279	0.94	42	113.636	-1.36	21	117.647	-2.12	16

Baud Rate (K)	SYNC = 0, BRGH = 1, BRG16 = 1 or SYNC = 1, BRG16 = 1								
	Fosc = 4.000 MHz			Fosc = 2.000 MHz			Fosc = 1.000 MHz		
	Actual Rate (K)	% Error	SPBRG Value (decimal)	Actual Rate (K)	% Error	SPBRG Value (decimal)	Actual Rate (K)	% Error	SPBRG Value (decimal)
0.3	0.300	0.01	3332	0.300	-0.04	1665	0.300	-0.04	832
1.2	1.200	0.04	832	1.201	-0.16	415	1.201	-0.16	207
2.4	2.404	0.16	415	2.403	-0.16	207	2.403	-0.16	103
9.6	9.615	0.16	103	9.615	-0.16	51	9.615	-0.16	25
19.2	19.231	0.16	51	19.230	-0.16	25	19.230	-0.16	12
57.6	58.824	2.12	16	55.555	3.55	8	—	—	—
115.2	111.111	-3.55	8	—	—	—	—	—	—

25.0 SPECIAL FEATURES OF THE CPU

PIC18F87J11 family devices include several features intended to maximize reliability and minimize cost through elimination of external components. These are:

- Oscillator Selection
- Resets:
  - Power-on Reset (POR)
  - Power-up Timer (PWRT)
  - Oscillator Start-up Timer (OST)
  - Brown-out Reset (BOR)
- Interrupts
- Watchdog Timer (WDT)
- Fail-Safe Clock Monitor
- Two-Speed Start-up
- Code Protection
- In-Circuit Serial Programming

The oscillator can be configured for the application depending on frequency, power, accuracy and cost. All of the options are discussed in detail in **Section 3.0 "Oscillator Configurations"**.

A complete discussion of device Resets and interrupts is available in previous sections of this data sheet. In addition to their Power-up and Oscillator Start-up Timers provided for Resets, the PIC18F87J11 family of devices have a configurable Watchdog Timer which is controlled in software.

The inclusion of an internal RC oscillator also provides the additional benefits of a Fail-Safe Clock Monitor (FSCM) and Two-Speed Start-up. FSCM provides for background monitoring of the peripheral clock and automatic switchover in the event of its failure. Two-Speed Start-up enables code to be executed almost immediately on start-up, while the primary clock source completes its start-up delays.

All of these features are enabled and configured by setting the appropriate Configuration register bits.

25.1 Configuration Bits

The Configuration bits can be programmed (read as '0') or left unprogrammed (read as '1') to select various device configurations. These bits are mapped starting at program memory location 300000h. A complete list is shown in Table 25-2. A detailed explanation of the various bit functions is provided in Register 25-1 through Register 25-6.

25.1.1 CONSIDERATIONS FOR CONFIGURING THE PIC18F87J11 FAMILY DEVICES

Unlike previous PIC18 microcontrollers, devices of the PIC18F87J11 family do not use persistent memory registers to store configuration information. The configuration bytes are implemented as volatile memory which means that configuration data must be programmed each time the device is powered up.

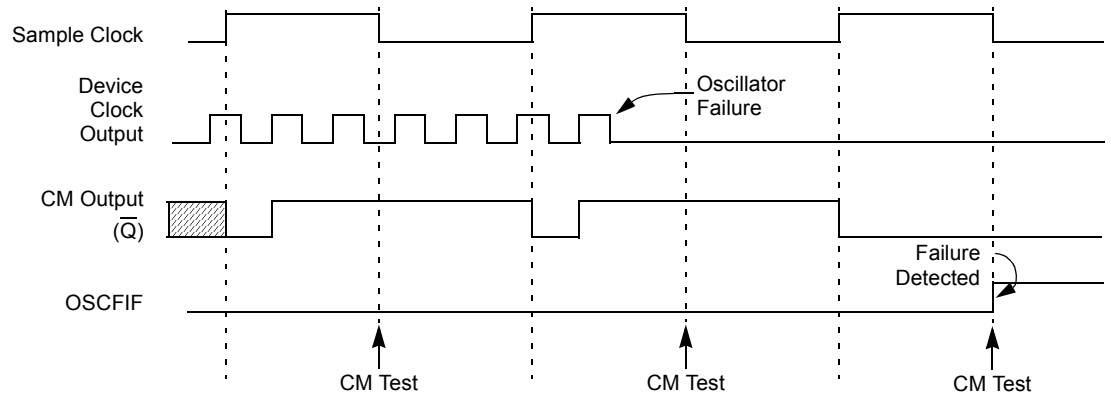
Configuration data is stored in the four words at the top of the on-chip program memory space, known as the Flash Configuration Words. It is stored in program memory in the same order shown in Table 25-2, with CONFIG1L at the lowest address and CONFIG3H at the highest. The data is automatically loaded in the proper Configuration registers during device power-up or after any device Reset.

When creating applications for these devices, users should always specifically allocate the location of the Flash Configuration Word for configuration data. This is to make certain that program code is not stored in this address when the code is compiled.

The four Most Significant bits of CONFIG1H, CONFIG2H and CONFIG3H in program memory should also be '1111'. This makes these Configuration Words appear to be NOP instructions in the remote event that their locations are ever executed by accident. Since Configuration bits are not implemented in the corresponding locations, writing '1's to these locations has no effect on device operation.

To prevent inadvertent configuration changes during code execution, all programmable Configuration bits are write-once. After a bit is initially programmed during a power cycle, it cannot be written to again. Changing a device configuration requires that power to the device be cycled.

FIGURE 25-5: FSCM TIMING DIAGRAM



Note: The device clock is normally at a much higher frequency than the sample clock. The relative frequencies in this example have been chosen for clarity.

25.5.2 EXITING FAIL-SAFE OPERATION

The fail-safe condition is terminated by either a device Reset or by entering a power-managed mode. On Reset, the controller starts the primary clock source specified in Configuration Register 2H (with any required start-up delays that are required for the oscillator mode, such as OST or PLL timer). The INTRC oscillator provides the device clock until the primary clock source becomes ready (similar to a Two-Speed Start-up). The clock source is then switched to the primary clock (indicated by the OSTS bit in the OSCCON register becoming set). The Fail-Safe Clock Monitor then resumes monitoring the peripheral clock.

The primary clock source may never become ready during start-up. In this case, operation is clocked by the INTRC oscillator. The OSCCON register will remain in its Reset state until a power-managed mode is entered.

25.5.3 FSCM INTERRUPTS IN POWER-MANAGED MODES

By entering a power-managed mode, the clock multiplexor selects the clock source selected by the OSCCON register. Fail-Safe Clock Monitoring of the power-managed clock source resumes in the power-managed mode.

If an oscillator failure occurs during power-managed operation, the subsequent events depend on whether or not the oscillator failure interrupt is enabled. If enabled (OSCFIF = 1), code execution will be clocked by the INTRC multiplexor. An automatic transition back to the failed clock source will not occur.

If the interrupt is disabled, subsequent interrupts while in Idle mode will cause the CPU to begin executing instructions while being clocked by the INTRC source.

25.5.4 POR OR WAKE-UP FROM SLEEP

The FSCM is designed to detect oscillator failure at any point after the device has exited Power-on Reset (POR) or low-power Sleep mode. When the primary device clock is either the EC or INTRC modes, monitoring can begin immediately following these events.

For HS or HSPLL modes, the situation is somewhat different. Since the oscillator may require a start-up time considerably longer than the FSCM sample clock time, a false clock failure may be detected. To prevent this, the internal oscillator block is automatically configured as the device clock and functions until the primary clock is stable (the OST and PLL timers have timed out). This is identical to Two-Speed Start-up mode. Once the primary clock is stable, the INTRC returns to its role as the FSCM source.

Note: The same logic that prevents false oscillator failure interrupts on POR, or wake from Sleep, will also prevent the detection of the oscillator's failure to start at all following these events. This can be avoided by monitoring the OSTS bit and using a timing routine to determine if the oscillator is taking too long to start. Even so, no oscillator failure interrupt will be flagged.

As noted in **Section 25.4.1 "Special Considerations for Using Two-Speed Start-up"**, it is also possible to select another clock configuration and enter an alternate power-managed mode while waiting for the primary clock to become stable. When the new power-managed mode is selected, the primary clock is disabled.

RCALL **Relative Call**

Syntax: RCALL n

Operands: -1024 ≤ n ≤ 1023

Operation: (PC) + 2 → TOS,
(PC) + 2 + 2n → PC

Status Affected: None

Encoding:

1101	1nnn	nnnn	nnnn

Description: Subroutine call with a jump up to 1K from the current location. First, return address (PC + 2) is pushed onto the stack. Then, add the 2's complement number '2n' to the PC. Since the PC will have incremented to fetch the next instruction, the new address will be PC + 2 + 2n. This instruction is a two-cycle instruction.

Words: 1

Cycles: 2

Q Cycle Activity:

Q1	Q2	Q3	Q4
Decode	Read literal 'n' PUSH PC to stack	Process Data	Write to PC
No operation	No operation	No operation	No operation

Example: HERE RCALL Jump

Before Instruction
PC = Address (HERE)
After Instruction
PC = Address (Jump)
TOS = Address (HERE + 2)

RESET **Reset**

Syntax: RESET

Operands: None

Operation: Reset all registers and flags that are affected by a $\overline{\text{MCLR}}$ Reset.

Status Affected: All

Encoding:

0000	0000	1111	1111

Description: This instruction provides a way to execute a $\overline{\text{MCLR}}$ Reset in software.

Words: 1

Cycles: 1

Q Cycle Activity:

Q1	Q2	Q3	Q4
Decode	Start reset	No operation	No operation

Example: RESET

After Instruction
Registers = Reset Value
Flags* = Reset Value

SUBLW **Subtract W from Literal**

Syntax: SUBLW k

Operands: $0 \le k \le 255$

Operation: $k - (W) \rightarrow W$

Status Affected: N, OV, C, DC, Z

Encoding:

0000	1000	kkkk	kkkk

Description: W is subtracted from the eight-bit literal 'k'. The result is placed in W.

Words: 1

Cycles: 1

Q Cycle Activity:

Q1	Q2	Q3	Q4
Decode	Read literal 'k'	Process Data	Write to W

Example 1: SUBLW 02h

Before Instruction
W = 01h
C = ?
After Instruction
W = 01h
C = 1 ; result is positive
Z = 0
N = 0

Example 2: SUBLW 02h

Before Instruction
W = 02h
C = ?
After Instruction
W = 00h
C = 1 ; result is zero
Z = 1
N = 0

Example 3: SUBLW 02h

Before Instruction
W = 03h
C = ?
After Instruction
W = FFh ; (2's complement)
C = 0 ; result is negative
Z = 0
N = 1

SUBWF **Subtract W from f**

Syntax: SUBWF f {,d {,a}}

Operands: $0 \le f \le 255$
$d \in [0,1]$
$a \in [0,1]$

Operation: $(f) - (W) \rightarrow$ dest

Status Affected: N, OV, C, DC, Z

Encoding:

0101	11da	ffff	ffff

Description: Subtract W from register 'f' (2's complement method). If 'd' is '0', the result is stored in W. If 'd' is '1', the result is stored back in register 'f'.

If 'a' is '0', the Access Bank is selected. If 'a' is '1', the BSR is used to select the GPR bank.

If 'a' is '0' and the extended instruction set is enabled, this instruction operates in Indexed Literal Offset Addressing mode whenever $f \le 95$ (5Fh). See **Section 26.2.3 "Byte-Oriented and Bit-Oriented Instructions in Indexed Literal Offset Mode"** for details.

Words: 1

Cycles: 1

Q Cycle Activity:

Q1	Q2	Q3	Q4
Decode	Read register 'f'	Process Data	Write to destination

Example 1: SUBWF REG, 1, 0

Before Instruction
REG = 3
W = 2
C = ?
After Instruction
REG = 1
W = 2
C = 1 ; result is positive
Z = 0
N = 0

Example 2: SUBWF REG, 0, 0

Before Instruction
REG = 2
W = 2
C = ?
After Instruction
REG = 2
W = 0
C = 1 ; result is zero
Z = 1
N = 0

Example 3: SUBWF REG, 1, 0

Before Instruction
REG = 1
W = 2
C = ?
After Instruction
REG = FFh ;(2's complement)
W = 2
C = 0 ; result is negative
Z = 0
N = 1

28.2 DC Characteristics: Power-Down and Supply Current PIC18F87J11 Family (Industrial)

PIC18F87J11 Family (Industrial)		Standard Operating Conditions (unless otherwise stated) Operating temperature -40°C ≤ TA ≤ +85°C for industrial				
Param No.	**Device**	**Typ**	**Max**	**Units**	**Conditions**	
	Power-Down Current (IPD)[1]					
	All devices	0.5	1.4	µA	-40°C	VDD = 2.0V[4] (**Sleep** mode)
		0.5	1.4	µA	+25°C	
		5.5	10.2	µA	+85°C	
	All devices	0.6	1.5	µA	-40°C	VDD = 2.5V[4] (**Sleep** mode)
		0.6	1.5	µA	+25°C	
		6.8	12.6	µA	+85°C	
	All devices	2.9	7	µA	-40°C	VDD = 3.3V[5] (**Sleep** mode)
		3.6	7	µA	+25°C	
		9.6	19	µA	+85°C	

Note 1: The power-down current in Sleep mode does not depend on the oscillator type. Power-down current is measured with the part in Sleep mode, with all I/O pins in a high-impedance state and tied to VDD or VSS, and all features that add delta current are disabled (such as WDT, Timer1 oscillator, BOR, etc.).

2: The supply current is mainly a function of the operating voltage, frequency and mode. Other factors, such as I/O pin loading and switching rate, oscillator type and circuit, internal code execution pattern and temperature, also have an impact on the current consumption.
The test conditions for all IDD measurements in active operation mode are:
OSC1 = external square wave, from rail-to-rail; all I/O pins tri-stated, pulled to VDD;
$\overline{\text{MCLR}}$ = VDD; WDT is enabled/disabled as specified.

3: Standard, low-cost 32 kHz crystals have an operating temperature range of -10°C to +70°C. Extended temperature crystals are available at a much higher cost.

4: Voltage regulator is disabled (ENVREG = 0, tied to VSS).

5: Voltage regulator is enabled (ENVREG = 1, tied to VDD, REGSLP = 1).

28.2 DC Characteristics: Power-Down and Supply Current PIC18F87J11 Family (Industrial) (Continued)

PIC18F87J11 Family (Industrial)		Standard Operating Conditions (unless otherwise stated) Operating temperature -40°C ≤ TA ≤ +85°C for industrial					
Param No.	**Device**	**Typ**	**Max**	**Units**	**Conditions**		
	Supply Current (IDD) Cont.(2,3)						
	All devices	3	9.4	µA	-40°C	VDD = 2.0V, VDDCORE = 2.0V(4)	FOSC = 31 kHz (**RC_IDLE** mode, internal oscillator source)
		3.3	9.4	µA	+25°C		
		8.5	17.2	µA	+85°C		
	All devices	4	10.5	µA	-40°C	VDD = 2.5V, VDDCORE = 2.5V(4)	
		4.3	10.5	µA	+25°C		
		10.3	19.5	µA	+85°C		
	All devices	34	82	µA	-40°C	VDD = 3.3V(5)	
		48	82	µA	+25°C		
		69	105	µA	+85°C		
	All devices	0.33	0.75	mA	-40°C	VDD = 2.0V, VDDCORE = 2.0V(4)	FOSC = 1 MHz (**RC_IDLE** mode, internal oscillator source)
		0.37	0.75	mA	+25°C		
		0.41	0.84	mA	+85°C		
	All devices	0.39	0.78	mA	-40°C	VDD = 2.5V, VDDCORE = 2.5V(4)	
		0.42	0.78	mA	+25°C		
		0.47	0.91	mA	+85°C		
	All devices	0.43	0.82	mA	-40°C	VDD = 3.3V(5)	
		0.48	0.82	mA	+25°C		
		0.54	0.95	mA	+85°C		
	All devices	0.53	0.98	mA	-40°C	VDD = 2.0V, VDDCORE = 2.0V(4)	FOSC = 4 MHz (**RC_IDLE** mode, internal oscillator source)
		0.57	0.98	mA	+25°C		
		0.61	1.12	mA	+85°C		
	All devices	0.63	1.14	mA	-40°C	VDD = 2.5V, VDDCORE = 2.5V(4)	
		0.67	1.14	mA	+25°C		
		0.72	1.25	mA	+85°C		
	All devices	0.7	1.27	mA	-40°C	VDD = 3.3V(5)	
		0.76	1.27	mA	+25°C		
		0.82	1.45	mA	+85°C		

Note 1: The power-down current in Sleep mode does not depend on the oscillator type. Power-down current is measured with the part in Sleep mode, with all I/O pins in a high-impedance state and tied to VDD or VSS, and all features that add delta current are disabled (such as WDT, Timer1 oscillator, BOR, etc.).

2: The supply current is mainly a function of the operating voltage, frequency and mode. Other factors, such as I/O pin loading and switching rate, oscillator type and circuit, internal code execution pattern and temperature, also have an impact on the current consumption.
The test conditions for all IDD measurements in active operation mode are:
OSC1 = external square wave, from rail-to-rail; all I/O pins tri-stated, pulled to VDD;
$\overline{MCLR}$ = VDD; WDT is enabled/disabled as specified.

3: Standard, low-cost 32 kHz crystals have an operating temperature range of -10°C to +70°C. Extended temperature crystals are available at a much higher cost.

4: Voltage regulator is disabled (ENVREG = 0, tied to VSS).

5: Voltage regulator is enabled (ENVREG = 1, tied to VDD, REGSLP = 1).